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Team Nexperia



40V, 600 mA double PNP switching transistor 2 July 2015

Product data sheet

1. General description

Double PNP switching transistor in a very small SOT363 (TSSOP6) Surface-Mounted Device (SMD) plastic package.

Double NPN complement: PMBT4401YS

2. Features and benefits

- Double general-purpose switching transistor
- AEC-Q101 qualified

3. Applications

Switching and linear amplification

4. Quick reference data

Table 1. Qui	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Per transistor						
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -150 \text{ mA}; \text{t}_{p} \le 300 \mu\text{s};$ $\delta \le 0.02; \text{ T}_{amb} = 25 ^{\circ}\text{C}$	100	-	300	
Per transistor	·					
V _{CEO}	collector-emitter voltage	open base	-	-	-40	V
I _C	collector current		-	-	-600	mA





40V, 600 mA double PNP switching transistor

5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter TR1	6 5 4	6 5 4
2	В	base TR1		
3	С	collector TR2		$\left(\begin{array}{c} TR1 \end{array} \right)$
4	E	emitter TR2		
5	В	base TR2	TSSOP6 (SOT363)	1 2 3
6	С	collector TR1		sym018

6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMBT4403YS	TSSOP6	plastic surface-mounted package; 6 leads	SOT363				

7. Marking

Table 4. Marking codes	
Type number	Marking code
	[1]
PMBT4403YS	BJ%

[1] % = placeholder for manufacturing site code

40V, 600 mA double PNP switching transistor

Limiting values 8.

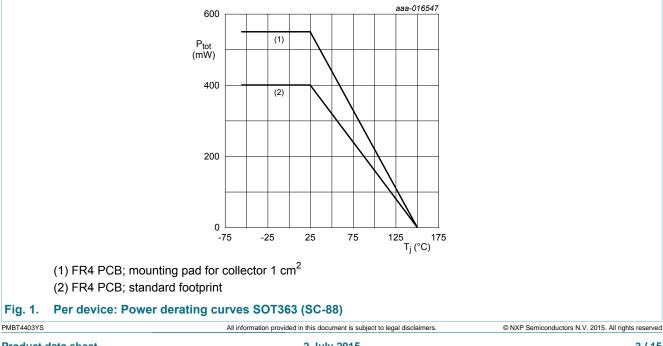
Table 5. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transist	tor		I		_	
V _{CBO}	collector-base voltage	open emitter		-	-40	V
V _{CEO}	collector-emitter voltage	open base		-	-40	V
V _{EBO}	emitter-base voltage	open collector		-	-5	V
I _C	collector current			-	-600	mA
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-800	mA
I _{BM}	peak base current			-	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	250	mW
			[2]	-	300	mW
Per device						
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1]	-	400	mW
			[2]	-	550	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for collector 1 cm²



Product data sheet

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9. Thermal characteristics

Table 6. The	rmal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per transistor							
R _{th(j-a)}	thermal resistance	_	[1]	-	-	500	K/W
	from junction to ambient		[2]	-	-	417	K/W
Per device							
R _{th(j-a)}	thermal resistance	in free air	[1]	-	-	313	K/W
	from junction to ambient		[2]	-	-	227	K/W

Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for collector 1 cm²

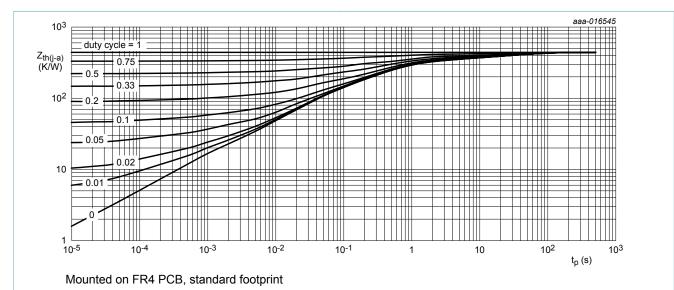
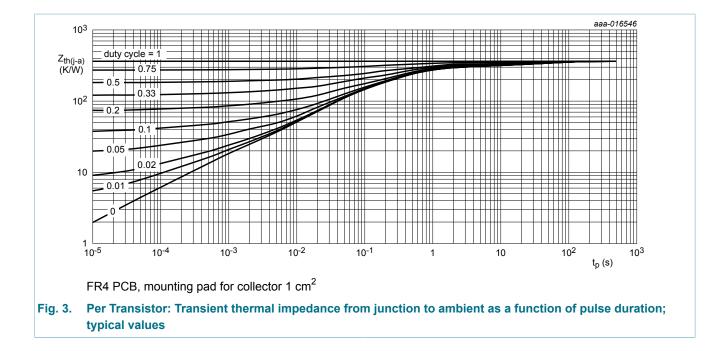


Fig. 2. Per transistor: Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

PMBT4403YS

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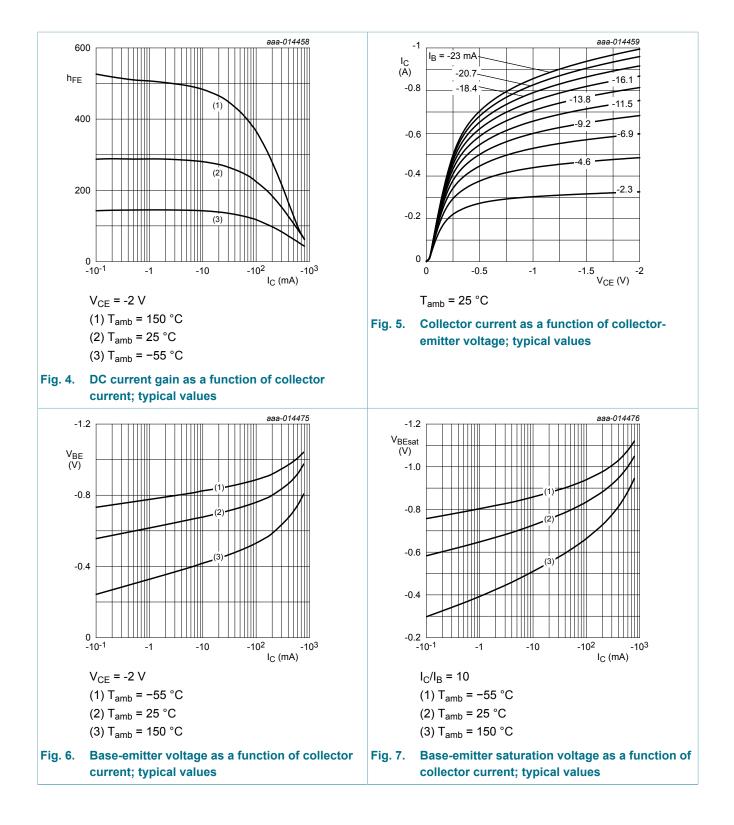
40V, 600 mA double PNP switching transistor

10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	tor					
I _{CBO}	collector-base cut-off	V_{CB} = -40 V; I _E = 0 A; T _{amb} = 25 °C	-	-	-50	nA
	current	V_{CB} = -40 V; I _E = 0 A; T _j = 125 °C	-	-	-10	μA
I _{EBO}	emitter-base cut-off current	V_{EB} = -5 V; I _C = 0 A; T _{amb} = 25 °C	-	-	-50	nA
h _{FE}	DC current gain	V_{CE} = -1 V; I _C = -0.1 mA; T _{amb} = 25 °C	30	-	-	
		V_{CE} = -1 V; I _C = -1 mA; T _{amb} = 25 °C	60	-	-	
		V_{CE} = -1 V; I _C = -10 mA; T _{amb} = 25 °C	100	-	-	
		V_{CE} = -2 V; I _C = -150 mA; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C	100	-	300	
		$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -500 \text{ mA}; \text{t}_{p} \le 300 \mu\text{s}; \\ \delta \le 0.02; \text{ T}_{amb} = 25 ^{\circ}\text{C}$	20	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = -150 \text{ mA}; I_{B} = -15 \text{ mA}; t_{p} \le 300 \mu\text{s};$ $\delta \le 0.02; T_{amb} = 25 ^{\circ}\text{C}$	-	-	-400	mV
		$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}; t_{p} \le 300 \mu\text{s};$ $\delta \le 0.02; T_{amb} = 25 ^{\circ}\text{C}$	-	-	-750	mV
V _{BEsat}	base-emitter saturation voltage	I_C = -150 mA; I_B = -15 mA; $t_p \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-	-950	mV
		I_{C} = -500 mA; I_{B} = -50 mA; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02; T_{amb} = 25 °C	-	-	-1.3	V
t _d	delay time	I _C = -150 mA; I _{Bon} = -15 mA;	-	-	15	ns
t _r	rise time	I_{Boff} = 15 mA; T_{amb} = 25 °C	-	-	30	ns
t _{on}	turn-on time	-	-	-	40	ns
t _s	storage time	-	-	-	300	ns
t _f	fall time	-	-	-	50	ns
t _{off}	turn-off time	_	-	-	350	ns
C _C	collector capacitance	V _{CB} = -10 V; I _E = 0 A; i _e = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	-	8.5	pF
C _E	emitter capacitance	V_{EB} = -500 mV; I _C = 0 A; i _c = 0 A; f = 1 MHz; T _{amb} = 25 °C	-	-	35	pF
f _T	transition frequency	V_{CE} = -10 V; I _C = -20 mA; f = 100 MHz; T _{amb} = 25 °C	200	-	-	MHz

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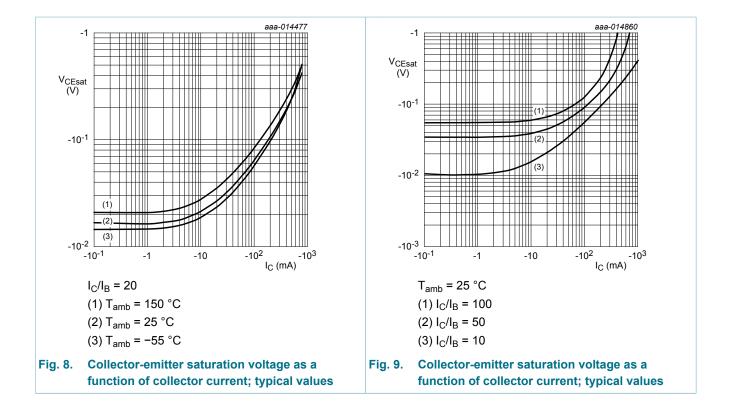


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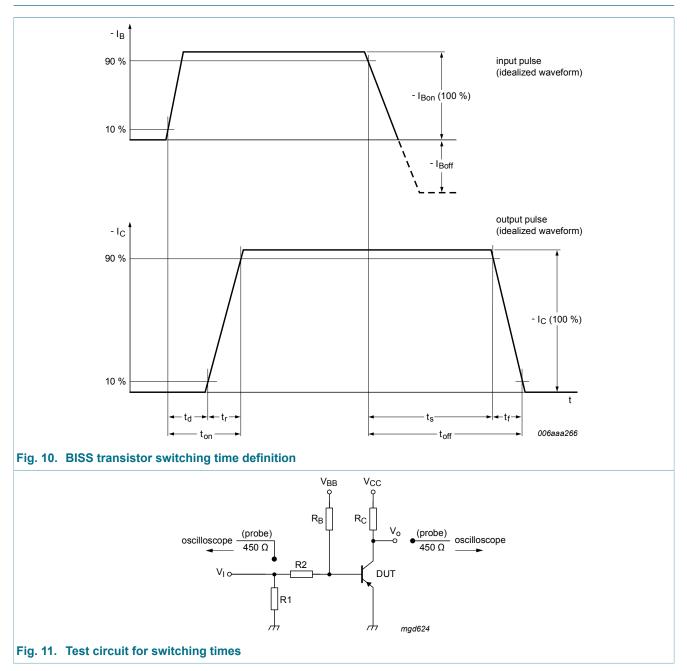
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11. Test information

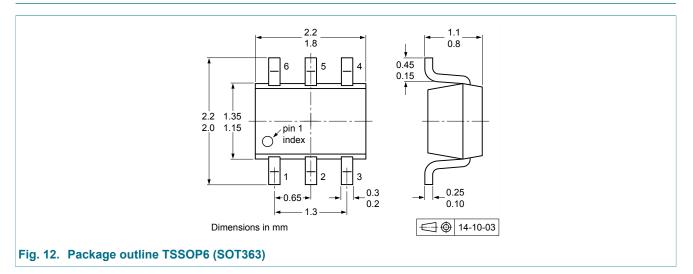


This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

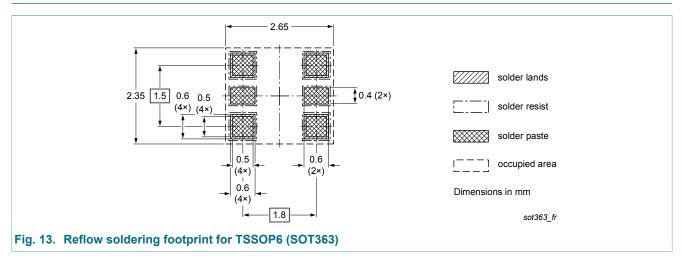
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12. Package outline

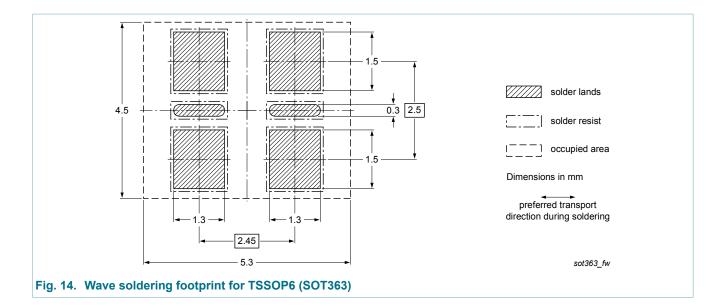


13. Soldering



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14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMBT4403YS v.1	20150702	Product data sheet	-	-			

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15. Legal information

15.1 Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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